

Multi Control Devices

Slide Operation Type Stick Switch with 8-contact and Center-push Function

SSAF Series



1.4mm height low-profile type with 8-contact and center push function.

Multi Control
Devices



Typical Specifications

Item	Specifications
Slide operating force	0.5 ^{+0.5} _{-0.25} N
Slide ON travel (mm)	0.65±0.25
Push operating force	2.5 ^{+0.7} _{-0.5} N
Push ON travel (mm)	0.2±0.1
Rating (max.) (Resistive load)	20mA 5V DC
Operating life	500,000cycles

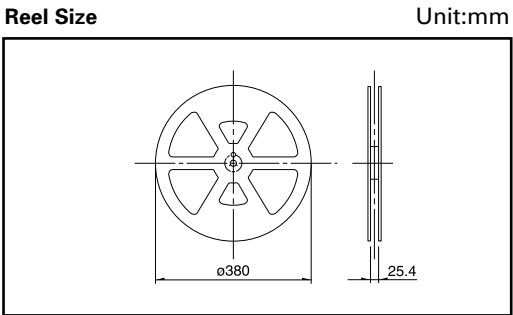
Product Line

Location Lug	Minimun order unit (pcs.)	Product No.	Drawing No.
Without	2,400	SSAF120100	1
With		SSAF220100	2

Variable
Resistor Type

Switch
Type

Taping Specification (Taping Packaging)



Number of packages (pcs.)			Tape width (mm)
1 reel	1 case/ Japan	1 case/export packing	
1,200	2,400	2,400	24

Note
Please place purchase orders per minimum order unit (integer).

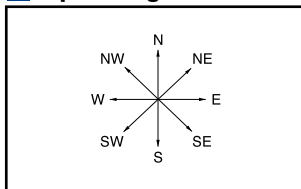
Refer to P.492 for soldering conditions.

Dimensions (With Center-push Type)

Unit:mm

No.	Style	PC board mounting hole dimensions
1		Example of pattern (Viewed from mounting side) C Common terminal G Ground terminal P Center push terminal
2		Example of pattern (Viewed from mounting side) C Common terminal G Ground terminal P Center push terminal

Operating Direction

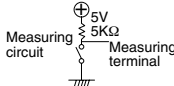


Output Code

[illegible]

List of Varieties

Multi Control
DevicesVariable
Resistor TypeSwitch
Type

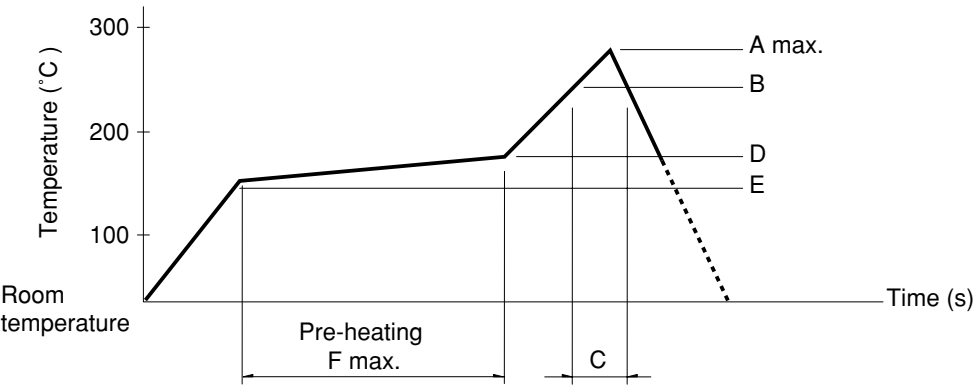
Series		Switch type							
		SKQU			SSAF	SRBE	SLLB	SLLB5 Small type	
Items	SKQUAA/SKQUBA	SKQUCA	SKQUDB						
Photo									
Function									
Dimensions (typical value) (mm)	W	10			10.85	12	11.8	9.5	
	D					11	11.4	8.8	
	H	7.1	10	8.6	3	3.8	3	2.2	
Outlined specifications	Number of operating shafts	Single-shaft							
	Shaft material	Resin							
	Directional resolution	4-direction			8-direction	—	2-direction		
	Directional operating feeling	With			Without	With	Without		
	Lever return mechanism	With				Without	With		
	Center-push switch	With/Without			With		With/ Without	With	
	Encoder	Without				With		Without	
Operating temperature range		-30°C to +85°C			-10°C to +60°C				
Rating (max.) (Resistive load)		50mA 12V DC			20mA 5V DC	1mA 5V DC	10mA 5V DC		
Electrical performance	Output voltage	_____			1V max. at 1mA 5V DC (Resistive load)				
	Directional resolution	4-direction			8-direction	—	2-direction		
	Insulation resistance	100MΩ min. 100V DC			10MΩ min. 100V DC	50MΩ min. 50V DC	100MΩ min. 100V DC		
	Voltage proof	250V AC for 1min.			100V AC for 1min.	50V AC for 1min.	100V AC for 1min.		
	Directional operating force	1.57 ^{+0.49} _{-0.59} N	1.57 ^{+0.39} _{-0.69} N		0.5N ^{+0.5} _{-0.35} N	—	0.65±0.3N		
Mechanical performance	Push operating force	_____	3.14±0.59N		2.5 ^{+0.7} _{-0.5} N	3.5±1.5N	2±1N	2.5±1N	
	Encoder detent torque	_____				3±2mN•m		_____	
	Terminal strength	_____					3N for 1min.		
	Actuator strength	Pushing direction	_____			50N			
		Operating direction	_____			50N	—	10N	
Endurance	Vibration	10 to 55 to 10Hz/min., the amplitude is 1.5mm for all the frequencies, in the 3 direction of X, Y and Z for 2 hours respectively							
	Operating life without load	_____					100,000cycles		
	Operating life with load (at rated load)	_____							
Environmental performance	Cold	-30±2°C for 96h			-40±2°C for 96h		-20±2°C for 96h		
	Dry heat	80±2°C for 96h			85±2°C for 96h				
	Damp heat	60±2°C, 90 to 95%RH for 96h			40±2°C, 90 to 95%RH for 96h				
Soldering	Manual soldering	350°C max. 3s max.			350±10°C 4 ⁺¹ ₀ s	350±5°C 3s max.			
	Dip soldering	260°C max. 5s max. (SKQUAA,CA)							
	Reflow soldering	Please see P.492 (SKQUBA,DB)			Please see P.492				
Page		482			484	486	488	490	

- Switch Type Multi Control Devices Soldering Conditions492
- Switch Type Multi Control Devices Cautions493

Soldering Conditions

Example of Reflow Soldering Condition

1. Heating method: Double heating method with infrared heater.
2. Temperature measurement: Thermocouple 0.1 to 0.2ϕ CA (K) or CC (T) at solder joints copper foil surface). A heat resistive tape should be used to fix thermocouple.
3. Temperature profile



Series(Reflow type)	A (°C) 3s max.	B (°C)	C (s)	D (°C)	E (°C)	F (s)
RKJXS	260	230	40	150	150	120
SLLB, SLLB5	240		20			
SKRV/SKRH/SKQUBA,DB/SSAF/SRBE	260		40	180		

Notes

1. The above temperature shall be measured on the mounting surface of a PC board. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the material, size thickness of PC boards and others. The above-stated conditions shall also apply to switch surface temperatures.
2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.